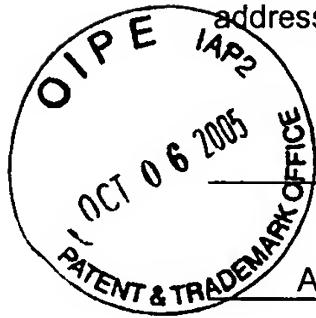


I hereby certify that this correspondence is being deposited with the United States Postal Service, with sufficient postage, as first class mail in an envelope addressed to:



Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450
on October 4, 2005

Date of Deposit

Anthony P. Curtis, Ph.D., Reg. No. 46,193

Name of applicant, assignee or
Registered Representative

Signature

10/4/05

Date of Signature

Our Case No. 10322/57

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
Kuang Chien Hsieh et al.)
Serial No. 10/680,509) Examiner: Vikki Trinh
Filing Date: October 7, 2003) Group Art Unit No. 2811
For ADHESIVE BONDING WITH LOW)
TEMPERATURE GROWN)
AMORPHOUS OR)
POLYCRYSTALLINE COMPOUND)
SEMICONDUCTORS)

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action of May 11, 2005, please amend the application as follows:

Amendments to the Claims begin on page 2 of this paper.

Remarks are provided on page 9 of this paper.